TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type ( $\pi$ -MOSVI)

# 2SK4012

#### **Switching Regulator Applications**

Unit: mm

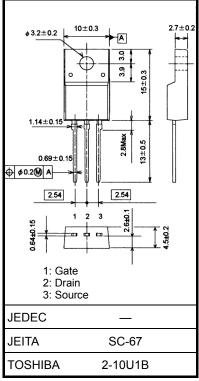
• Low drain–source ON-resistance : R<sub>DS</sub> (ON) = 0. 33  $\Omega$  (typ.)

High forward transfer admittance : |Y<sub>fs</sub>| = 8.5 S (typ.)
 Low leakage current : I<sub>DSS</sub> = 100 μA (max) (V<sub>DS</sub> = 500 V)

Enhancement mode : V<sub>th</sub> = 2.0~4.0 V (V<sub>DS</sub> = 10 V, I<sub>D</sub> = 1 mA)

### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristic		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	500	V
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		$V_{DGR}$	500	V
Gate-source voltage		V <sub>GSS</sub>	±30	V
Drain current	DC (Note 1)	I <sub>D</sub>	13	Α
	Pulse (Note 1)	I <sub>DP</sub>	52	Α
Drain power dissipation	n (Tc = 25°C)	P <sub>D</sub>	45	W
Single-pulse avalanche energy (Note 2)		E <sub>AS</sub>	1170	mJ
Avalanche current		I <sub>AR</sub>	13	Α
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	4.5	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature range		T <sub>stg</sub>	-55~150	°C



Weight: 1.7 (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

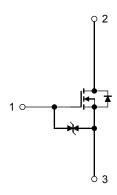
Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	2.78	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD}$  = 90 V,  $T_{ch}$  = 25°C (initial), L = 11.8 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AR}$  = 13 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.





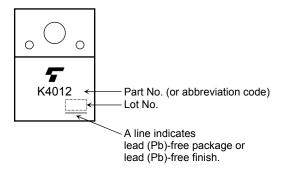
## **Electrical Characteristics (Ta = 25°C)**

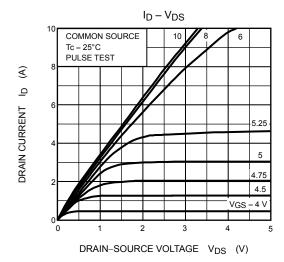
Charae	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I <sub>G</sub> = ±10 μA, V <sub>DS</sub> = 0 V	±30	_	_	V
Drain cutoff curr	ent	I <sub>DSS</sub>	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	500	_	_	V
Gate threshold v	voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source O	N-resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.5 A	_	0.33	0.4	Ω
Forward transfer	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 6.5 A	4.0	8.5	_	S
Input capacitano	e	C <sub>iss</sub>		_	2400	_	
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	18	_	pF
Output capacitance		Coss		_	220	_	
Switching time	Rise time	t <sub>r</sub>	$V_{GS}$ $V_{OD}$	_	25	_	
	Turn-on time	t <sub>on</sub>		_	70	_	
	Fall time	t <sub>f</sub>		_	10	_	ns
	Turn-off time	t <sub>off</sub>		_	95	_	
Total gate charg plus gate-drain)		Qg			50	_	
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}$		30	_	nC
Gate-drain ("Miller") charge		Q <sub>gd</sub>			20	_	

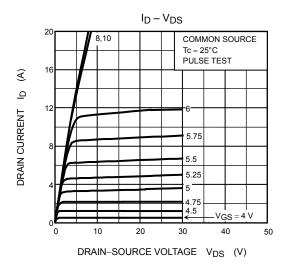
# Source-Drain Ratings and Characteristics (Ta = 25°C)

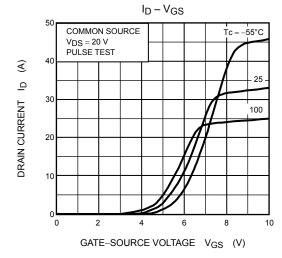
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	13	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	52	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 13 A, V <sub>GS</sub> = 0 V	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 13 A, V <sub>GS</sub> = 0 V	_	1000	_	ns
Reverse recovery charge	Q <sub>rr</sub>	dl <sub>DR</sub> / dt = 100 A / μs	_	11	_	μC

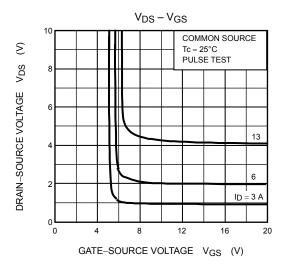
## Marking

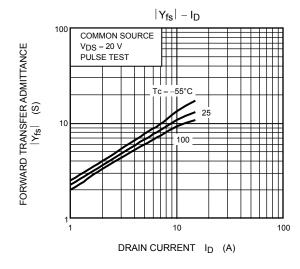


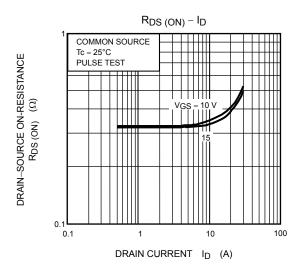




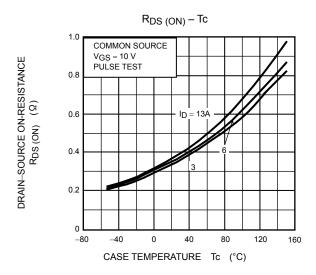


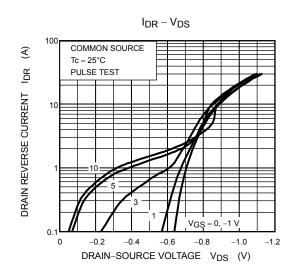


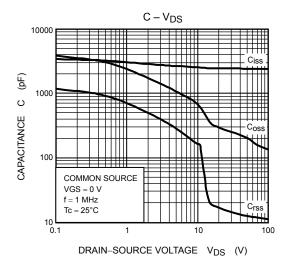


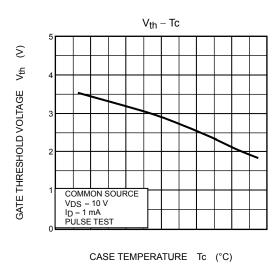


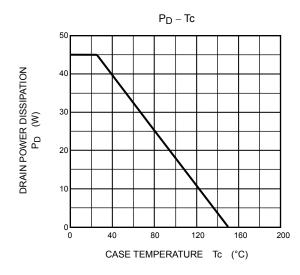
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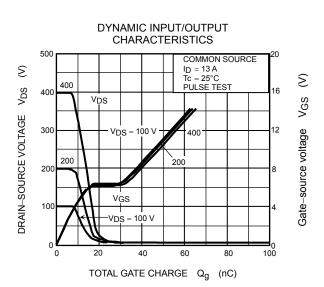


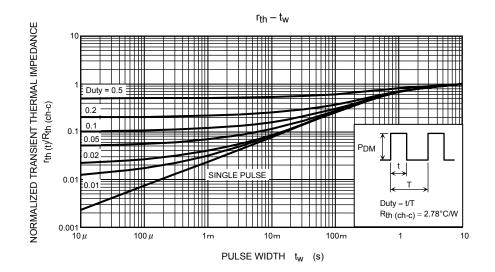


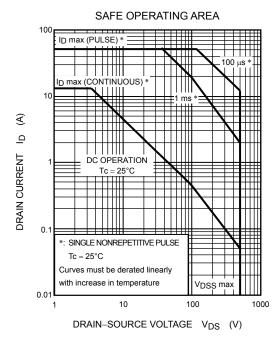


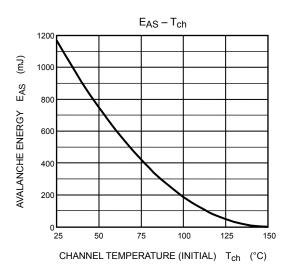


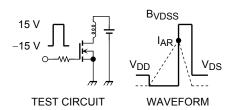












$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 90~V,~L = 11.8~mH \end{aligned} \qquad EAS &= \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{BVDSS}{BVDSS - VDD} \right) \end{aligned}$$

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